

REPLY UNDER 37 CFR 1.116 EXPEDITED PROCEDURE TECHNOLOGY CENTER 2800

Attorney Docket No. 051876P352

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Patent Application of:

Byung-Seop Hong

Serial No. 10/648,183

Filed: August 25, 2003

For: METHOD FOR RELEASING STRESS

DURING SEMICONDUCTOR DEVICE

FABRICATION

Examiner: Trung Q. Dang

Art Unit: 2823

Mail Stop A/F Commissioner for Patents Post Office Box 1450 Alexandria, Virginia 22313-1450

AMENDMENT AND RESPONSE TO FINAL OFFICE ACTION

Sir:

In response to the Final Office Action mailed February 24, 2005, regarding the above-referenced application, Applicant respectfully requests entry of the amendment set forth below in consideration of the remarks that follow.

Interest Co-2005 Amich 6-31-05